



PC Board Layout

Component Side Shown

NOTES:

MATERIAL :

1.HOUSING MATER AL :GLASS FILLED POLYESTER UL94V-0.

2.CONTACT MATERIAL :PHOSPHOR'BRONZE Ø0.46mm.
3.PLATING :GOLD PLATING OVER NICKEL.

4.SHIELD :0.23mm THICKNESS COPPER ALLOY WITH NICKEL PLATED.

5.LED :OPTION

ELECTRICAL:

1.VOLTAGE RATING :125 VAC RMS. 2.CURRENT RATING :1.5 AMP.

3.CONTACT RESISTANCE :30 MILLIOHMS MAX.

4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.

5.DIELECTRIC WITHSTANDING

RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

1. DURRABILITY :750 CYCLES MIN.

2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40℃~+85℃ 2. OPERATION : 0°C TO 70°C.

